Electronic Patent Application Fee Transmittal							
Application Number:	10739456						
Filing Date:	17-Dec-2003						
Title of Invention:	Tape circuit substrate having wavy beam leads and semiconductor chip package using the same						
First Named Inventor:	Dae-Woo Son						
Filer:	Alexander Charles Johnson/Li mei Vermilya						
Attorney Docket Number:	9903-068						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Independent claims in excess of 3		1201	1	200	200		
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 1 month with \$0 paid	1251	1	120	120
Miscellaneous:				
Request for continued examination	1801	1	790	790
	Tota	1110		